TUV WANGEMENT SERVICE



An ISO/TS 16949, ISO 9001 and ISO 14001 Certified Company

NPN SILICON PLANAR EPITAXIAL TRANSISTOR

CSC2271

TO-92 Plastic Package



Horizontal Deflection Driver Applications.

ABSOLUTE MAXIMUM RATINGS (Ta=25°C unless specified otherwise)

DESCRIPTION	SYMBOL	VALUE	UNIT
Collector Emitter Voltage	BV_CEO	300	V
Collector Base Voltage	BV_CBO	300	V
Emitter Base Voltage	BV_{EBO}	6	V
Collector Current	I_{C}	100	mA
Peak Collector Current	I_{CP}	300	mA
Collector Power Dissipation	P_{C}	750	mW
Operating And Storage Junction	T_{j},T_{stg}	-55 to +150	°C
Temperature Range			

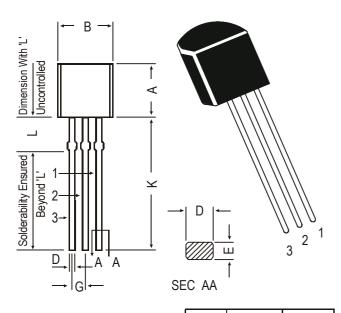
ELECTRICAL CHARACTERISTICS (Ta=25°C unless specified otherwise)

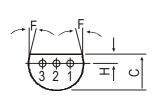
DESCRIPTION	SYMBOL	TEST CONDITION	VALUE		_	UNIT
			MIN	TYP	MAX	•
Collector Cut off Current	I_{CBO}	$V_{CB} = 20V, I_{E} = 0$			1.0	μΑ
Emitter Cut off Current	I_{EBO}	V_{EB} =6 V , I_C = 0			1.0	μΑ
DC Current Gain	h_{FE}	V_{CE} =10 V , I_{C} =10 mA	40		200	
Base Emitter Saturation Voltage	$V_{BE(sat)}$	I_C =20mA, I_B =2mA			1.0	V
Collector Emitter Saturation Voltage	$V_{CE(sat)}$	I _C =20mA,I _B =2mA			0.6	V
DYNAMIC CHARACTERISTICS						
Transition Frequency	f_{T}	I_C =10mA, V_{CE} =30V	50			MHz
Collector Output Capacitance	C_ob	I _E =0, V _{CB} =10V f=1MHz			7.5	pF
h _{FE} CLASSIFICATION :	С	D		E		
	40-80	60-120	1	00-200		

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TO-92 Transistors on Tape and Ammo Pack





Α	4.32	5.33
В	4.45	5.20
С	3.18	4.19
D	0.41	0.55
Е	0.35	0.50
F	5 DI	EG
G	1.14	1.40
Н	1.14	1.53

12.70

1.982

MAX.

2.082

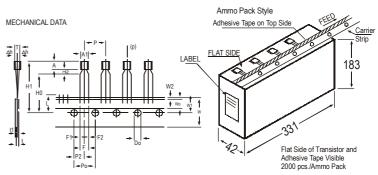
PIN CONFIGURATION

- 1. BASE
- COLLECTOR
- 3. EMITTER

ΔII	din	nin	sions	in	mm

K

L



All dimensions in mm unless specified otherwise

ITEM	0.44501	SPECIFICATION				
IIEM	SYMBOL	MIN.	NOM.	MAX.	TOL.	REMARKS
BODY WIDTH BODY HEIGHT BODY THICKNESS PITCH OF COMPONENT FEED HOLE PITCH	A1 A T P	4.0 4.8 3.9	12.7 12.7	4.8 5.2 4.2	±1 ±0.3	CUMULATIVE PITCH ERROR 1.0 mm/20
FEED HOLE CENTRE TO COMPONENT CENTRE	P2		6.35		±0.4	PITCH TO BE MEASURED AT BOTTOM OF CLINCH
DISTANCE BETWEEN OUTER LEADS COMPONENT ALIGNMENT TAPE WIDTH HOLD-DOWN TAPE WIDTH HOLE POSITION	F △h W Wo W1		5.08 0 18 6	1	+0.6 -0.2 ±0.5 ±0.2 +0.7 -0.5	AT TOP OF BODY
HOLD-DOWN TAPE POSITION LEAD WIRE CLINCH HEIGHT COMPONENT HEIGHT LENGTH OF SNIPPED LEADS FEED HOLE DIAMETER TOTAL TAPE THICKNESS LEAD - TO - LEAD DISTANCEF1,	W2 Ho H1 L Do t F2		0.5 16 4 2.54	23.25 11.0 1.2	±0.2 ±0.5 ±0.2 +0.4 -0.1	t1 0.3 - 0.6
CLINCH HEIGHT PULL - OUT FORCE	H2 (P)	6N		3	-0.1	

NOTES

- MAXIMUM ALIGNMENT DEVIATION BETWEEN LEADS NOT TO BE GREATER THAN 0.2 mm.
 MAXIMUM NON-CUMULATIVE VARIATION BETWEEN TAPE FEED HOLES SHALL NOT EXCEED 1 mm IN 20
- PITCHES.
 HOLDDOWN TAPE NOT TO EXCEED BEYOND THE EDGE(S) OF CARRIER TAPE AND THERE SHALL BE NO
- EXPOSURE OF ADHESIVE.

 4. NO MORE THAN 3 CONSECUTIVE MISSING COMPONENTS ARE PERMITTED.
- 5. A TAPE TRAILER, HAVING AT LEAST THREE FEED HOLES ARE REQUIRED AFTER THE LAST COMPONENT.
 6. SPLICES SHALL NOT INTERFERE WITH THE SPROCKET FEED HOLES.

Packing Detail

PACKAGE	STANDARD PACK		INNER CARTON BOX		OUTER CARTON BOX		
	Details	Net Weight/Qty	Size	Qty	Size	Qty	Gr Wt
TO-92 Bulk	1K/polybag	200 gm/1K pcs	3" x 7.5" x 7.5"	5K	17" x 15" x 13.5"	80K	23 kgs
TO-92 T&A	2K/ammo box	645 gm/2K pcs	12.5" x 8" x 1.8"	2K	17" x 15" x 13.5"	32K	12.5 kgs

Notes CSC2271

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Disclaimer

The product information and the selection guides facilitate selection of the CDIL's Discrete Semiconductor Device(s) best suited for application in your product(s) as per your requirement. It is recommended that you completely review our Data Sheet(s) so as to confirm that the Device(s) meet functionality parameters for your application. The information furnished in the Data Sheet and on the CDIL Web Site/CD are believed to be accurate and reliable. CDIL however, does not assume responsibility for inaccuracies or incomplete information. Furthermore, CDIL does not assume liability whatsoever, arising out of the application or use of any CDIL product; neither does it convey any license under its patent rights nor rights of others. These products are not designed for use in life saving/support appliances or systems. CDIL customers selling these products (either as individual Discrete Semiconductor Devices or incorporated in their end products), in any life saving/support appliances or systems or applications do so at their own risk and CDIL will not be responsible for any damages resulting from such sale(s).

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